# onsemi

# <u>Silicon Carbide (SiC)</u> <u>Schottky Diode</u> – EliteSiC, 10 A, 1700 V, D1, TO-247-2L

# NDSH10170A

#### Description

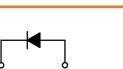
Silicon Carbide (SiC) Schottky Diodes use a completely new technology that provides superior switching performance and higher reliability compared to Silicon. No reverse recovery current, temperature independent switching characteristics, and excellent thermal performance sets Silicon Carbide as the next generation of power semiconductor. System benefits include highest efficiency, faster operating frequency, increased power density, reduced EMI, and reduced system size and cost.

#### Features

- Max Junction Temperature 175°C
- Avalanche Rated 156 mJ
- High Surge Current Capacity
- Positive Temperature Coefficient
- Ease of Paralleling
- No Reverse Recovery / No Forward Recovery
- These Devices are Halogen Free/BFR Free and are RoHS Compliant

#### Applications

- SMPS, Solar Inverter, UPS
- Power Switching Circuits

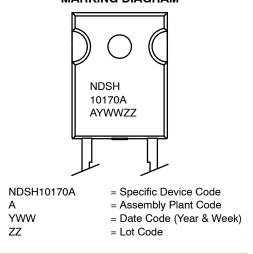


1. Cathode 2. Anode

Schottky Diode



MARKING DIAGRAM



#### **ORDERING INFORMATION**

See detailed ordering and shipping information on page 2 of this data sheet.

## NDSH10170A

| Symbol                            | Parameter   | Value                                    | Unit        |    |
|-----------------------------------|---|--|-------------|----|
| V <sub>RRM</sub>                  | Peak Repetitive Reverse Voltage                                       |  | 1700        | V  |
| E <sub>AS</sub>                   | Single Pulse Avalanche Energy (Note 1)                                | 156                                      | mJ          |    |
| ١ <sub>F</sub>                    | Continuous Rectified Forward Current @ T <sub>C</sub> < 157°C         |  | 10          | A  |
|                                   | Continuous Rectified Forward Current @ $T_C$ < $\sim$                 | 16                                       | 1           |    |
| I <sub>F, Max</sub>               | Non-Repetitive Peak Forward Surge Current                             | T <sub>C</sub> = 25°C, 10 μs             | 868         | A  |
|                                   |   | T <sub>C</sub> = 150°C, 10 μs            | 798         | A  |
| I <sub>F,SM</sub>                 | Non-Repetitive Forward Surge Current                                  | Half-Sine Pulse, t <sub>p</sub> = 8.3 ms | 105         | A  |
| I <sub>F,RM</sub>                 | Repetitive Forward Surge Current         Half-Sine Pulse, tp = 8.3 ms |  | 25          | A  |
| Ptot                              | Power Dissipation   | $T_{\rm C} = 25^{\circ}{\rm C}$          | 185         | W  |
|                                   |   | T <sub>C</sub> = 150°C                   | 31          | W  |
| T <sub>J</sub> , T <sub>STG</sub> | Operating and Storage Temperature Range                               |  | –55 to +175 | °C |

#### ABSOLUTE MAXIMUM RATINGS (T<sub>J</sub> = 25°C unless otherwise noted)

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected. 1.  $E_{AS}$  of 156 mJ is based on starting  $T_J = 25^{\circ}$ C, L = 0.5 mH,  $I_{AS} = 25$  A, V = 50 V.

#### THERMAL CHARACTERISTICS

| Symbol          | Parameter   | Value | Unit |
|-----------------|---|-------|------|
| $R_{\theta JC}$ | Thermal Resistance, Junction to Case, Max                     | 0.81  | °C/W |
| $R_{\thetaJA}$  | R <sub>0JA</sub> Thermal Resistance, Junction to Ambient, Max |       | °C/W |

#### **ELECTRICAL CHARACTERISTICS** (T<sub>J</sub> = $25^{\circ}$ C unless otherwise noted)

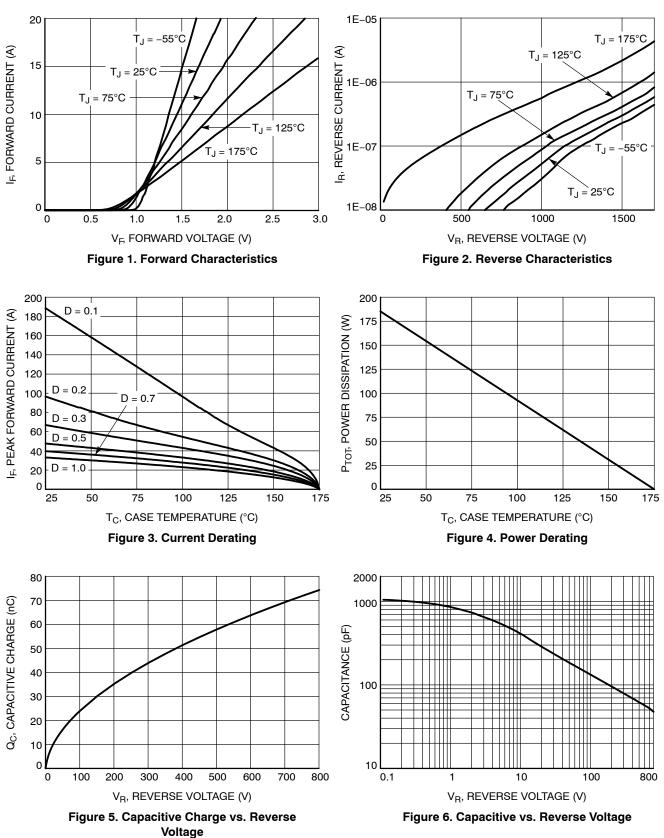
| Symbol         | Parameter               | Test Condition   | Min | Тур  | Мах  | Unit |
|----------------|-------------------------|--|-----|------|------|------|
| V <sub>F</sub> | Forward Voltage         | I <sub>F</sub> = 10 A, T <sub>J</sub> = 25°C                 | -   | 1.50 | 1.75 | V    |
|                |                         | I <sub>F</sub> = 10 A, T <sub>J</sub> = 125°C                | -   | 1.87 | -    |      |
|                |                         | I <sub>F</sub> = 10 A, T <sub>J</sub> = 175°C                | -   | 2.19 | -    |      |
| I <sub>R</sub> | Reverse Current         | $V_{R} = 1700 \text{ V}, \text{ T}_{J} = 25^{\circ}\text{C}$ | -   | 0.09 | 40   | μΑ   |
|                |                         | $V_{R}$ = 1700 V, $T_{J}$ = 125°C                            | -   | 0.42 | 60   |      |
|                |                         | $V_{R}$ = 1700 V, $T_{J}$ = 175°C                            | -   | 2.46 | 100  |      |
| $Q_{C}$        | Total Capacitive Charge | V = 800 V  | -   | 74   | -    | nC   |
| С              | Total Capacitance       | V <sub>R</sub> = 1 V, f = 100 kHz                            | -   | 856  | -    | pF   |
|                |                         | V <sub>R</sub> = 400 V, f = 100 kHz                          | -   | 69   | -    |      |
|                |                         | V <sub>R</sub> = 800 V, f = 100 kHz                          | -   | 48   | -    |      |

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

#### **ORDERING INFORMATION**

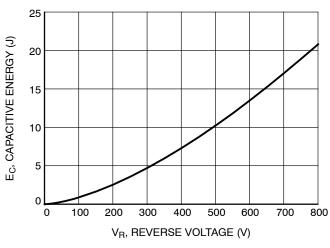
| Part Number | Top Marking | Package                                | Shipping        |
|-------------|-------------|--|-----------------|
| NDSH10170A  | NDSH10170A  | TO-247-2LD<br>(Pb-Free / Halogen Free) | 30 Units / Tube |

### NDSH10170A



### NDSH10170A

TYPICAL CHARACTERISTICS (T<sub>J</sub> = 25°C UNLESS OTHERWISE NOTED)





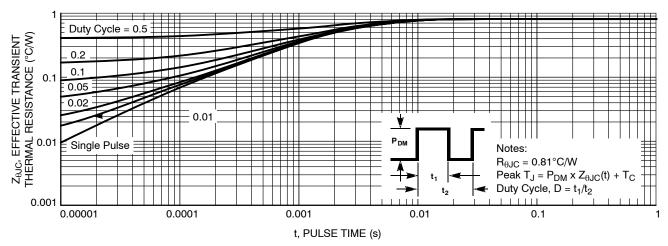
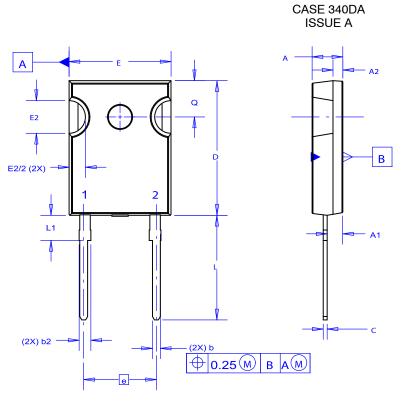


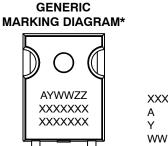
Figure 8. Junction-to-Case Transient Thermal Response Curve





NOTES: UNLESS OTHERWISE SPECIFIED.

- A. DIMENSIONS ARE EXCLUSIVE OF BURRS, MOLD
- FLASH, AND TIE BAR EXTRUSIONS.
- B. ALL DIMENSIONS ARE IN MILLIMETERS.
- C. DRAWING CONFORMS TO ASME Y14.5 2009.
- D. DIMENSION A1 TO BE MEASURED IN THE REGION DEFINED BY L1.
- E. LEAD FINISH IS UNCONTROLLED IN THE REGION DEFINED BY L1.



XXXXX = Specific Device Code A = Assembly Location Y = Year

TO-247-2LD

V = Work Week

ΖZ

= Assembly Lot Code

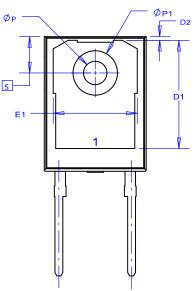
\*This information is generic. Please refer to device data sheet for actual part marking. Pb– Free indicator, "G" or microdot " ■", may or may not be present. Some products may not follow the Generic Marking.

 
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 DESCRIPTION:
 TO-247-2LD
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|             | MILLIMETERS |       |       |  |  |
|-------------|-------------|-------|-------|--|--|
| DIM         | MIN         | NOM   | MAX   |  |  |
| Α           | 4.58        | 4.70  | 4.82  |  |  |
| A1          | 2.20        | 2.40  | 2.60  |  |  |
| A2          | 1.40        | 1.50  | 1.60  |  |  |
| b           | 1.17        | 1.26  | 1.35  |  |  |
| b2          | 1.53        | 1.65  | 1.77  |  |  |
| с           | 0.51        | 0.61  | 0.71  |  |  |
| D           | 20.32       | 20.57 | 20.82 |  |  |
| D1          | 13.08       | ~     | ~     |  |  |
| D2          | 0.51        | 0.93  | 1.35  |  |  |
| E           | 15.37       | 15.62 | 15.87 |  |  |
| E1          | 12.81       | ~     | ~     |  |  |
| E2          | 4.96        | 5.08  | 5.20  |  |  |
| е           | ~           | 11.12 | ~     |  |  |
| L           | 15.75       | 16.00 | 16.25 |  |  |
| L1          | 3.69        | 3.81  | 3.93  |  |  |
| ØР          | 3.51        | 3.58  | 3.65  |  |  |
| Ø <b>P1</b> | 6.60        | 6.80  | 7.00  |  |  |
| Q           | 5.34        | 5.46  | 5.58  |  |  |
| S           | 5.34        | 5.46  | 5.58  |  |  |

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